PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
JI-CHAO LI	12/20/2010
BO DENG	12/20/2010
XIAO-FENG CAO	12/20/2010

RECEIVING PARTY DATA

Name:	HONG FU JIN PRECISION INDUSTRY (ShenZhen) CO., LTD.	
Street Address:	No. 2, 2nd Donghuan Road,Longhua Town, Bao' an District	
City:	Shenzhen City, Guangdong Province	
State/Country:	CHINA	

Name:	HON HAI PRECISION INDUSTRY CO., LTD.	
Street Address:	66,CHUNG SHAN ROAD	
City:	Tu-Cheng,Taipei Hsien	
State/Country:	TAIWAN	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12982906

CORRESPONDENCE DATA

Fax Number: (909)978-6366

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

9099786584 Phone:

Raymond.Chew@foxconn.com Email:

Correspondent Name: Raymond J. Chew Address Line 1: 288 South Mayo Avenue

City of Industry, CALIFORNIA 91789 Address Line 4:

ATTORNEY DOCKET NUMBER: US36254

PATENT

REEL: 025567 FRAME: 0268 501394336

NAME OF SUBMITTER:	Raymond J. Chew
Total Attachments: 2 source=US36254101230ASM#page1.tif source=US36254101230ASM#page2.tif	

PATENT REEL: 025567 FRAME: 0269

Attorney Docket No.: US36254

ASSIGNMENT

In consideration of value received, the receipt and sufficiency of which are hereby acknowledged, the undersigned ASSIGNOR(S)

1.	Ji-Chao Li	, residing at	Shenzhen, Guangdong, China
2.	Bo Deng	, residing at	Shenzhen, Guangdong, China
3.	Xiao-Feng Cao	, residing at	Shenzhen, Guangdong, China
4.		, residing at	
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6.		, residing at	· · · · · · · · · · · · · · · · · · ·
7.		, residing at	
8.		, residing at	
hereby sell(s), assign(s) and transfer(s) unto: HONG FU JIN PRECISION INDUSTRY (SHENZHEN) CO., LTD. having a principal place of business at No. 2, 2nd Donghuan Road, Longhua Town, Bao'an District, Shenzhen City, Guangdong Province 518109, P.R.C. and HON HAI PRECISION INDUSTRY CO., LTD. having a principal place of business at 66,Chung Shan Road, Tu-Cheng City, Taipei Hsien, Taiwan, R.O.C. hereafter designated "ASSIGNEE" the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100, in the invention and all patent applications including any and all divisions, continuations, substitutes, and reissues thereof, and all resulting patents, known as MOTHERBOARD SYSTEM HAVING HEAT DISSIPATING DEVICE for which the undersigned			
[] previously executed Ser. No and filing date of [x] is executing concurrently herewith			

AND the undersigned hereby authorize(s) and request(s) the United States Commissioner of Patents and Trademarks to issue said Letters Patent to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agree(s) that the attorneys of record in said application, if any, shall hereafter act on behalf of said ASSIGNEE:

an application for Letters Patent of United States of America

AND the undersigned hereby agree(s) to testify and execute any papers for ASSIGNEE, its successors, assigns and legal representatives, deemed essential by ASSIGNEE to ASSIGNEE's full protection and title in and to the invention hereby transferred.

> **PATENT REEL: 025567 FRAME: 0270**

1.	J:-chao Li	Dec.20,2010
	Ji-Chao Li	Date
2.	Bo Deng Bo Deng	Dec.20,2010
	Bo Deng	Date
3.	Xiao-Ferg Cao	Dec.20,2010
	Xiao-Feng Cao	Date
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